

Sir:

Transmitted herewith for filing is the Patent Application of:

Inventor: **HUAN-JUST LIN, MING-HUAN TSAI, LI-TE S. LIN, YUAN-HUNG CHIU, HAN-JAN TAO**

For: **FULLY DRY, SI RECESS FREE PROCESS FOR REMOVING HIGH K DIELECTRIC LAYER**

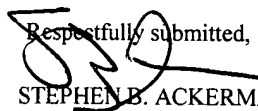
Enclosed are:

- ☒ 3 sheets of drawing(s) - formal.
- ☒ An assignment of the invention to **Taiwan Semiconductor Manufacturing Co.**
- ☐ An associate power of attorney ☐ Applicant claims small entity status
- ☐ Request & Certification under 35 USC 122(b)(2)(b)(i)

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	OTHER THAN A SMALL ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE	40 - 20 =	20	x 18 =	\$ 770.
TOTAL CLAIMS	40 - 20 =	20	x 18 =	\$ 360.
INDEP CLAIMS	2 - 3 =	0	x 84 =	\$ 0.
SUB TOTAL				\$ 1,130.
ASSIGNMENT				\$40.
TOTAL				\$ 1,170.

- ☒ Please charge my Deposit Account No. 19-0033 in the amount of \$ 1,170. A duplicate copy of this sheet is enclosed.
- ☒ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.
- ☒ Any additional filing fees required under 37 CFR §1.16.
- ☒ Any patent application processing fees under 37 CFR §1.17.


Respectfully submitted,

STEPHEN B. ACKERMAN, REG. NO. 37,761

EXPRESS MAIL CERTIFICATE

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I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and/or Attorney requests the date of deposit as the Filing Date.

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